

# N210

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The USRP Network Series offers high-bandwidth, high-dynamic range processing capability. The Gigabit Ethernet interface of the USRP Network Series allows high-speed streaming capability up to 50 MS/s in both directions (8-bit samples). These features, combined with plug-and-play MIMO capability make the USRP Network an ideal candidate for software defined radio systems with demanding performance requirements.

- 50 MHz of RF bandwidth with 8 bit samples
- 25 MHz of RF bandwidth with 16 bit samples
- Gigabit Ethernet connectivity
- MIMO capable - requires two or more USRP N200 devices as motherboard has one daughterboard slot (1 RX + 1 TX connectors)
- Onboard FPGA processing
- FPGA: Xilinx® Spartan® 3A-DSP XC3SD1800A
- ADCs: 14-bits 100 MS/s
- DACs: 16-bits 400 MS/s
- Ability to lock to external 5 or 10 MHz clock reference
- TCXO Frequency Reference (~2.5ppm)
- Optional internal GPS locked reference oscillator
- FPGA code can be changed with Xilinx® ISE® WebPACK? tools
- Frequency range: DC - 6 GHz with suitable daughterboard



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- SBX-40
- UBX-40
- WBX-40
- CBX-40

- LFRX / LFTX
- BasicRX / BasicTX
- DBSRX2 (EOL)
- RFX Series (EOL)
- TVRX2 (EOL)

- SSB/LO Suppression -35/50 dBc
- Phase Noise 1.8 GHz 10kHz -80 dBc/Hz
- Phase Noise 1.8 GHz 100kHz -100 dBc/Hz
- Phase Noise 1.8 GHz 1MHz -137 dBc/Hz
- Power Output 15 dBm
- IIP3 (@ typ NF) 0 dBm
- Typical Noise Figure 5 dB

- Ettus Research recommends to always use the latest stable version of UHD

- Current Hardware Revision: 4
- Minimum version of UHD required: 3.8.0

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22 x 16 x 5 cm

1.2 kg

- File:cu usrp-n2x0 motherboard.pdf
- File:cu ettus-usrp-n2x0.pdf

- Motherboard

- Enclosure

- N200/N210: 25 °C

- 10% to 90% non-condensing

#### N200/N210 Schematics

Part Number	Description	Schematic ID (Page)
AD9777	Dual Channel, 16-Bit DAC	U3 (1)
ADS62P4X	Dual Channel, 14-Bit ADC	U2 (1)
XC3SD3400AFG676	FPGA	U1 (2,8,9,10,11,12)
AD9510	Clock Distribution IC	U9 (4)
ET1011C2	Gigabit Ethernet Transceiver	U12 (6)
CY7C1354C	Pipelined SRAM	U19 (7)
MAX232	Drivers/Receiver	U25 (10)

- Utilization statistics are subject to change between UHD releases. This information is current as of UHD 3.9.4 and was taken directly from Xilinx Vivado 2014.4.

#### Device utilization summary:

Selected Device : 3sd1800afg676-5

Number of Slices:	18356	out of	16640	110% (*)
Number of Slice Flip Flops:	20466	out of	33280	61%
Number of 4 input LUTs:	32968	out of	33280	99%
Number used as logic:	28511			
Number used as Shift registers:	3945			
Number used as RAMs:	512			
Number of IOs:	338			
Number of bonded IOBs:	331	out of	519	63%
IOB Flip Flops:	342			
Number of BRAMs:	41	out of	84	48%
Number of GCLKs:	6	out of	24	25%
Number of DCMs:	1	out of	8	12%
Number of DSP48s:	31	out of	84	36%

Device utilization summary:

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Selected Device : 3sd3400afg676-5

Number of Slices:	18349	out of	23872	76%
Number of Slice Flip Flops:	20475	out of	47744	42%
Number of 4 input LUTs:	32986	out of	47744	69%
Number used as logic:	28529			
Number used as Shift registers:	3945			
Number used as RAMs:	512			
Number of IOs:	338			
Number of bonded IOBs:	331	out of	469	70%
IOB Flip Flops:	342			
Number of BRAMs:	41	out of	126	32%
Number of GCLKs:	6	out of	24	25%
Number of DCMs:	1	out of	8	12%
Number of DSP48s:	31	out of	126	24%

- Gigabit Ethernet

As of December 1st, 2010 all Ettus Research products are RoHS compliant unless otherwise noted. More information can be found at <http://ettus.com/legal/rohs-information>

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- [Media:volatility USRP N200 N210 r2.pdf](#)

For a detailed guide to recovering the N200/N210, please see the [N200/N210 Device Recovery](#) application note.

[FPGA Resources](#)

[UHD Stable Binaries](#)

[UHD Source Code on Github](#)